PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hiroji Fukui	11/25/2008
Kenichi Aoki	11/20/2008
Kunihiro Ichimura	11/20/2008
Minoru Suezaki	11/27/2008
Toshio Enami	11/27/2008
Hideaki Ishizawa	11/28/2008
Takao Unate	11/28/2008
Hiroshi Kobayashi	11/25/2008

RECEIVING PARTY DATA

Name:	SEKISUI CHEMICAL CO., LTD.	
Street Address:	4-4, Nishitemma 2-chome, Kita-ku	
City:	Osaka-city, Osaka	
State/Country:	Japan	
Postal Code:	530-8565	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12304262

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: MIY-0302

PATENT

500727024 REEL: 021957 FRAME: 0671

NAME OF SUBMITTER:	Lee Cheng
Total Attachments: 1 source=MIY-0302_Assignment#page1.tif	

PATENT REEL: 021957 FRAME: 0672

Docket No.	

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by

[Insert ASSIGNEE's Name(s) Address(es)] SEKISUI CHEMICAL CO., LTD.

4-4, Nishitemma 2-chome, Kita-ku, Osaka-city, Osaka 530-8565 JAPAN

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE all of the right, title and interest to the invention entitled

[Title of Invention]

[*If the assignment is being filed after the filing of the application, this section must be completed]

PROCESS FOR PRODUCING PATTERNED FILM AND PHOTOSENSITIVE RESIN COMPOSITION

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

*filed on , Serial No.

(Cheng Law Group, PLLC is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with application and any continuing, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, division, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

[Signature(s) of Assignor(s)]

Hirryi Juhi	Hiroji FUKUI	25/11/2008
(SIGNAŢŲRE)	(TYPE NAME)	(DATE)
Kenichi Aoki	Kenichi AOKI	20/11/2008
(SIGNATURE)	(TYPE NAME)	(DATE)
Kimilino Ichimmer	Kunihiro ICHIMURA	20/11/2008
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Minone Suezaki	Minoru SUEZAKI	27/11/200f
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Zshiv Enami	Toshio ENAMI	27/11/2008
(SIGNATURE)	(TYPE NAME)	(DATE)
Hideaki Shizawa	Hideaki ISHIZAWA	28/11/2008
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Takao Unute	Takao UNATE	28/11/2008
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Hinoshi Kebayashi	Hiroshi KOBAYASHI	25/11/2008
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RECORDED: 12/10/2008

REEL: 021957 FRAME: 0673